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Applicant :

Address :

Sample Name : Triangle mini lantern

Model : FL3317

Manufacturer :

Address :

Received Date : Mar. 06, 2017

**Test Period** : Mar. 06, 2017 ~ Mar. 10, 2017

Test Requested : As requested by client, to evaluate the compliance of the submitted sample with the Directive

2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction

of the use of certain hazardous substances in electrical and electronic equipment.

**Test Method** : 1. a) To refer to the standard IEC 62321-2:2013, review was performed for the samples

disjointed from the submitted articles.

b) To refer to the standard IEC 62321-1:2013, tests were performed for the samples

indicated by the photos in this report.

c) To refer to the standard IEC 62321-3-1:2013: Screening by XRF Spectroscopy.

d) Wet chemical test

1) to refer to IEC 62321-5:2013, determine the Cadmium, Lead content by ICP-OES.

2) to refer to IEC 62321-4:2013, determine the Mercury content by ICP-OES.

3) to refer to IEC 62321-7-1:2015 & IEC 62321:2008, determine the Hexavalent

Chromium content by UV-VIS.

4) to refer to IEC 62321-6:2015, determine the Polybrominated Biphenyls (PBBs)

and Polybrominated Diphenyl Ethers(PBDEs) by GC-MS.

**Test Results**: Please refer to next page (s).





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### Conclusion:

Basing on the test results obtained from the homogenous materials, the submitted sample **COMPLIES** with the requirements stated in the Annex II of RoHS Directive 2011/65/EU.

Signed for and on behalf of

EMTEK (Shenzhen) C

Tested by:

Qu xiang —

Test engineer

Reviewed by:

2 M M

Approved by:

Tiowa

Technical supervisor

Pascal Shi
Authorized signatory
Mar. 10, 2017





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### **Test Results:**

No.	Sample Description	Restricted Substances	Results of EDXRF <sup>(1)</sup>	Results of Chemical Testing <sup>(2)</sup> (mg/kg)	Remark <sup>(3)</sup>	
	Pedestal-white hard plastic	Cd	BL			
		Pb	BL			
1		Hg	BL	<del></del>	Non comment	
	Piaolio	Cr	BL			
		Br	BL			
CALLER OF		Cd	BL			
		Pb	BL			
2	Lampshade-white transparent hard plastic	Hg	BL		Non comment	
	transparent nara piastio	Cr	BL			
		Br	BL			
		Cd	BL			
		Pb	BL		Non comment	
3	Battery lid-black hard plastic	Hg	BL			
		Cr	BL			
		Br	BL			
TELL EL	Magnet	Cd	BL		Non comment	
		Pb	BL			
4		Hg	BL			
		Cr	BL			
		Br	BL			
		Cd	BL		Non comment	
		Pb	BL			
5	Keypad-black soft	Hg	BL	<del>-</del>		
	plastic	Cr	BL			
		Br	BL			
METERS OF		Cd	BL			
		Pb	BL			
6	Hook-black hard plastic	Hg	BL		Non comment	
		Cr	BL			
		Br	BL			
Fel Ville		Cd	BL			
		Pb	BL	<u></u>	Non comment	
7	Screw-silvery metal	Hg	BL			
		Cr	BL			
		Br	NA			





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No.	Sample Description	Restricted Substances	Results of EDXRF <sup>(1)</sup>	Results of Chemical Testing <sup>(2)</sup> (mg/kg)	Remark <sup>(3)</sup>	
	Spring-copper metal	Cd	BL			
		Pb	BL		Non comment	
8		Hg	BL			
		Cr	BL			
		Br	NA			
		Cd	BL			
		Pb	BL			
9	Electrode plate-copper metal	Hg	BL		Non comment	
	motar	Cr	BL			
		Br	NA			
		Cd	BL			
		Pb	BL		Non comment	
10	Solder-silvery metal	Hg	BL			
		Cr	BL			
		Br	NA			
	Wire-silvery metal	Cd	BL		Non comment	
		Pb	BL			
11		Hg	BL			
		Cr	BL			
		Br	NA			
	Wire-red soft plastic	Cd	BL		Non comment	
		Pb	BL			
12		Hg	BL	<u></u> -		
		Cr	BL			
		Br	BL			
EFEN.		Cd	BL			
		Pb	BL			
13	SMD triode	Hg	BL	PBBs: ND PBDEs: ND	Non comment	
		Cr	BL	F DDL3. ND		
		Br	X			
a A Kit		Cd	BL			
		Pb	BL		Non comment	
14	SMD resistor	Hg	BL			
		Cr	BL			
		Br	BL			





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No.	Sample Description	Restricted Substances	Results of EDXRF <sup>(1)</sup>	Results of Chemical Testing <sup>(2)</sup> (mg/kg)	Remark <sup>(3)</sup>	
	Inductance-copper metal	Cd	BL			
		Pb	BL		Non comment	
15		Hg	BL	<u></u>		
		Cr	BL			
		Br	NA			
		Cd	BL			
		Pb	BL			
16	Inductance-black solid	Hg	BL		Non comment	
		Cr	BL			
		Br	BL			
STATE OF		Cd	BL			
		Pb	BL		Non comment	
17	Button switch-black hard plastic	Hg	BL			
		Cr	BL			
A VERY		Br	BL			
	Button switch-silvery metal	Cd	BL		Non comment	
		Pb	BL			
18		Hg	BL			
		Cr	BL			
		Br	NA			
		Cd	BL		Non comment	
	Button switch-copper metal	Pb	BL			
19		Hg	BL	<del></del>		
KEREN SEEN KE		Cr	BL			
E VILLE		Br	NA			
		Cd	BL			
A THE		Pb	BL			
20	Button switch-silvery metal	Hg	BL	<u></u> -	Non comment	
	niciai	Cr	BL			
		Br	NA			
ed Viet		Cd	BL	PBBs: ND PBDEs: ND		
Kerrely Ergely		Pb	BL			
21	Button switch-black	Hg	BL		Non comment	
	hard plastic	Cr	BL			
		Br	X			





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No.	Sample Description	Restricted Substances	Results of EDXRF <sup>(1)</sup>	Results of Chemical Testing <sup>(2)</sup> (mg/kg)	Remark <sup>(3)</sup>	
	SMD capacitor	Cd	BL			
		Pb	BL			
22		Hg	BL	<del></del>	Non comment	
		Cr	BL			
		Br	BL			
		Cd	BL			
		Pb	BL			
23	IC-black solid	Hg	BL		Non comment	
		Cr	BL			
THE BUY		Br	BL			
e Viet		Cd	BL			
Carley V.		Pb	BL		Non comment	
24	IC-silvery metal	Hg	BL			
CETE OF		Cr	BL			
A VIET		Br	NA			
4	SMD resistor	Cd	BL		Non comment	
A VIET S		Pb	BL			
25		Hg	BL			
		Cr	BL			
		Br	BL			
		Cd	BL			
		Pb	BL			
26	Solder-silvery metal	Hg	BL		Non comment	
HE BY YE		Cr	BL			
E VILLE		Br	NA			
TELETAN S		Cd	BL			
A THE		Pb	BL			
27	SMD LED (white)	Hg	BL		Non comment	
		Cr	BL			
		Br	BL			
e de Viet e	SMD LED (yellow)	Cd	BL		Non comment	
28		Pb	BL			
		Hg	BL			
		Cr	BL			
er liet		Br	BL			





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No.	Sample Description	Restricted Substances	Results of EDXRF <sup>(1)</sup>	Results of Chemical Testing <sup>(2)</sup> (mg/kg)	Remark <sup>(3)</sup>
	White PCB	Cd	BL		Non comment
		Pb	BL	PBBs: ND PBDEs: ND	
29		Hg	BL		
		Cr	BL	T BBES. NB	
		Br	X		





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- Remark: (1) ① Results are obtained by XRF for primary screening, and further wet chemical testing by ICP-OES / AAS (for Cd, Pb, Hg), UV-VIS (for Cr(VI)) and GC/MS (for PBBs, PBDEs) is recommended to be performed, if an inconclusive result was found (as "X" in below table)(unit: mg/kg).
  - ② OL = Over Limit, BL = Below Limit, X = Inconclusive, NA= Not Applicable.
  - ③ The XRF screening test for RoHS elements The reading may be different to the actual content in the sample be of non-uniformity composition.

Element	Polymer	Metal	Composite Materials
Cd	BL ≤(70-3σ )< X <(130+3σ )≤ OL	BL ≤(70-3σ )< X <(130+3σ )≤ OL	LOD < X <(150+3σ )≤ OL
Pb	BL ≤(700-3σ )< X <(1300+3σ ) ≤ OL	BL ≤(700-3σ )< X <(1300+3σ ) ≤ OL	BL ≤(500-3σ )< X <(1500+3σ )≤ OL
Hg	BL ≤(700-3σ )< X <(1300+3σ ) ≤ OL	BL ≤(700-3σ )< X <(1300+3σ ) ≤ OL	BL ≤(500-3σ )< X <(1500+3σ )≤ OL
Br	$BL \leq (300-3\sigma) < X$	NA	BL ≤ (250-3σ )< X
Cr	BL ≤ (700-3σ )< X	BL ≤ (700-3σ )< X	BL ≤ (500-3σ )< X

- (2) ① mg/kg = ppm = 0.0001%, ND = Not Detected (Less than method detection limit).
  - 2 Unit and Method Detection Limit (MDL) in wet chemical test.

	Test items	Pb	Cd	Hg	Cr <sup>6+</sup> (Non-metal)	PBBs(single)	PBDEs(single)
0	Unit	mg/kg	mg/kg	mg/kg	mg/kg	mg/kg	mg/kg
100	MDL	2	2	2	2	5	5

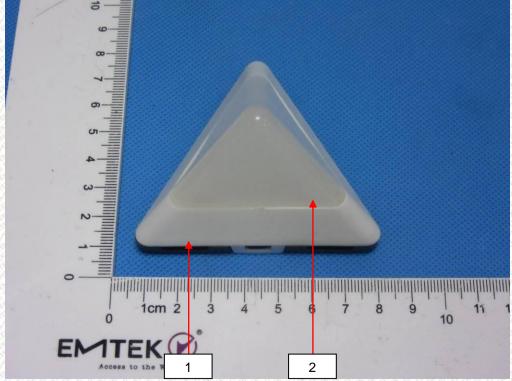
- 3 According to IEC 62321:2008, result on Cr<sup>6+</sup> for metal sample is shown as Positive/Negative. Negative = Absence of Cr<sup>6+</sup> coating, Positive = Presence of Cr<sup>6+</sup> coating. Storage condition and production date of the tested sample are unavailable and thus results of Cr<sup>6+</sup> represent status of the sample at the time of testing.
- 4 According to IEC 62321-3-1:2013, this column represents the results of wet chem test. And "---" means no need to perform wet chem test, when the XRF screening results are qualified.
- (3) This column represents the exempted decoration of material or other related testing sample's information. And "Non comment" means no note.





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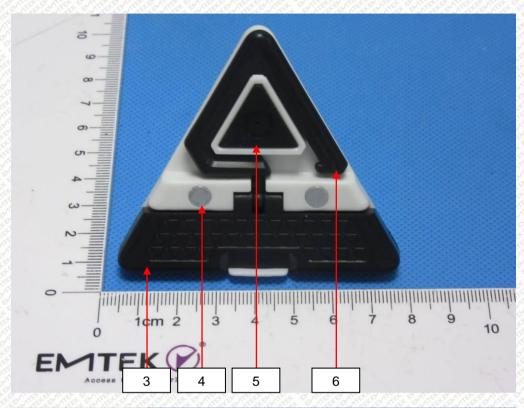


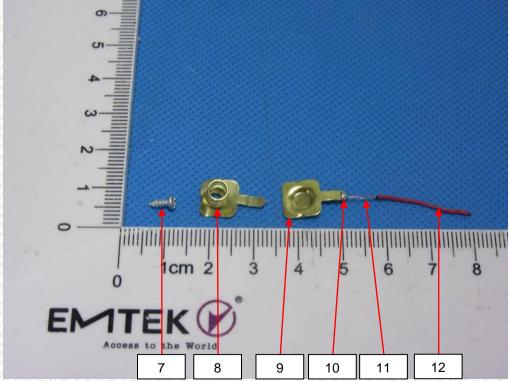






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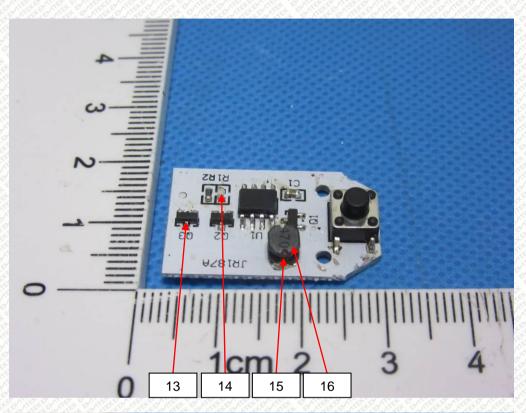


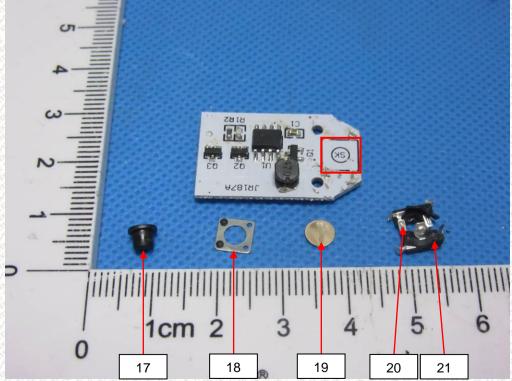






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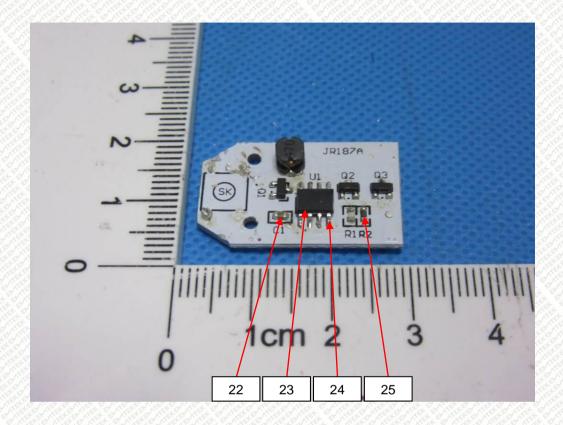








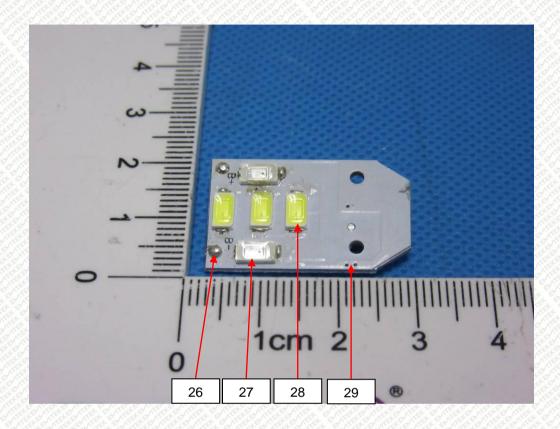
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\*\*\* End of Report \*\*\*

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### ANNEX

### RESTRICTED SUBSTANCES LIST

Restricted substances and maximum concentration values tolerated by weight in homogeneous materials Lead (0.1%)

Mercury (0.1%)

Cadmium (0.01%)

Hexavalent chromium (0.1%)

Polybrominated biphenyls (PBB) (0.1%)

Polybrominated diphenyl ethers (PBDE) (0.1%)

#### **EXEMPTION LIST**

- Mercury in single capped (compact) fluorescent lamps not exceeding (per burner):
- 1(a) For general lighting purposes < 30W: 5mg (expires on 31 December 2011; 3.5mg may be used per burner after 31 December 2011 until 31 December 2012; 2.5mg shall be used per burner after 31 December 2012)
- 1(b) For general lighting purposes ≥ 30W and <50W: 5mg (expires on 31 December 2011; 3.5mg may be used per burner after 31
- For general lighting purposes ≥ 50W and <150W: 5mg 1(c)
- For general lighting purposes ≥ 150W: 15mg 1(d)
- 1(e) For general lighting purposes with circular or square structural shape and tube diameter ≤17mm (no limitation of use until 31 December 2011; 7mg may be used per burner after 31 December 2011)
- 1(f) For special purposes: 5mg
- For general lighting purposes < 30 W with a lifetime equal or above 20 000 h: 3,5 mg (Expires on 31 December 2017) 1(g)
- Mercury in double-capped linear fluorescent lamps for general lighting purples not exceeding (per lamp): 2(a)
- 2(a)(1) Tri-band phosphor with normal lifetime and a tube diameter < 9mm (e.g. T2): 5mg (expires on 31 December 2011; 4mg may be used per lamp after 31 December 2011)
- Tri-band phosphor with normal lifetime and a tube diameter ≥ 9mm and ≤ 17mm (e.g. T5): 5mg (expires on 31 December 2(a)(2) 2011; 3mg may be used per lamp after 31 December 2011)
- 2(a)(3) Tri-band phosphor with normal lifetime and a tube diameter > 17mm and ≤ 28mm (e.g. T8): 5mg (expires on 31 December 2011; 3.5mg may be used per lamp after 31 December 2011)
- 2(a)(4) Tri-band phosphor with normal lifetime and a tube diameter > 28mm (e.g. T12): 5mg (expires on 31 December 2012; 3.5mg may be used per lamp after 31 December 2012)
- Tri-band phosphor with long lifetime (≥ 25000h): 8mg (expires on 31 December 2011; 5mg may be used per lamp after 31 2(a)(5)
- 2(b) Mercury in other fluorescent lamps not exceeding (per lamp):
- 2(b)(2)
- Non-linear halophosphate lamps (all diameters): 15mg (expires on 13 April 2016)

  Non-linear tri-band phosphor lamps with tube diameter > 17mm (e.g. T9) (no limitation of use until 31 December 2011; 15mg 2(b)(3)may be used per lamp after 31 December 2011)
- Lamps for other general lighting and special purposes (e.g. induction lamps) (no limitation of use until 31 December 2011; 2(b)(4)15mg may be used per lamp after 31 December 2011)
- Mercury in cold cathode fluorescent lamps and external electrode fluorescent lamps (CCFL and EEFL) for special purposes not 3 exceeding (per lamp):
- Short length (≤ 500mm) (No limitation of use until 31 December 2011; 3.5mg may be used per lamp after 31 December 2011) 3(a)
- Medium length (> 500m and ≤ 1500mm) (No limitation of use until 31 December 2011; 5mg may be used per lamp after 31 3(b)
- Long length (> 1500mm) (No limitation of use until 31 December 2011; 13mg may be used per lamp after 31 December 2011) 3(c)
- Mercury in other low pressure discharge lamps (per lamp) (no limitation of use until 31 December 2011; 15mg may be used per 4(a) lamp after 31 December 2011)
- 4(b) Mercury in High Pressure Sodium (vapour) lamps for general lighting purposes not exceeding (per burner) in lamps with improved colour rendering index Ra > 60:
- P ≤ 155W (no limitation of use until 31 December 2011; 40mg may be used per burner after 31 December 2011) 4(b)-I
- 4(b)-II 155W < P ≤ 405W (no limitation of use until 31 December 2011; 40mg may be used per burner after 31 December 2011)
- 4(b)-III P > 405W (no limitation of use until 31 December 2011; 40mg may be used per burner after 31 December 2011)
- Mercury in other High Pressure Sodium (vapour) lamps for general lighting purposes not exceeding (per burner): 4(c)
- 4(c)-l P≤ 155W (no limitation of use until 31 December 2011; 25mg may be used per burner after 31 December 2011) 4(c)-II 155W < P ≤405W (no limitation of use until 31 December 2011; 30mg may be used per burner after 31 December 2011)
- P > 405W (no limitation of use until 31 December 2011; 40mg may be used per burner after 31 December 2011) 4(c)-III
- Mercury in High Pressure Mercury (vapour) lamps (HPMV) (expires on 13 April 2015) 4(d)
- Mercury in metal halide lamps (MH) 4(e)
- 4(f) Mercury in other discharge lamps for special purposes not specifically mentioned in this Annex
- 4(g) Mercury in hand crafted luminous discharge tubes used for signs, decorative or architectural and specialist lighting and lightartwork, where the mercury content shall be limited as follows: (Expires on 31 December 2018)
  - 20 mg per electrode pair + 0,3 mg per tube length in cm, but not more than 80 mg, for outdoor applications and indoor applications exposed to temperatures below 20 °C;





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## **ANNEX**

### **EXEMPTION LIST**

#### Continued

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5(a)	(b) 15 mg per electrode pair + 0,24 mg per tube length in cm, but not more than 80 mg, for all other indoor applications. Lead in glass of cathode ray tubes
5(a) 5(b)	Lead in glass of fluorescent tubes not exceeding 0.2% by weight
6(a)	Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0.35% lead by weight
6(b)	Lead as an alloying element in aluminium containing up to 0.4% lead by weight
6(c)	Copper alloy containing up to 4% lead by weight.
7(a)	Lead in high melting temperature type solders (i.e. lead based alloys containing 85% by weight or more lead)
7(b)	Lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signalling, transmission, and network management for telecommunications
7(c)-l	Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g.
7(0)1	piezoelectronic devices, or in a glass or ceramic matrix compound
7(c)-II	Lead in dielectric ceramic in capacitors for a rated voltage of 125V AC or 250V DC or higher
7(c)-III	Lead in dielectric ceramic in capacitors for a rated voltage of less than 125V AC or 250V DC (expires on 1 January 2013 and after that date may be used in spare parts for EEE placed on the market before 1 January 2013).
7(c)-IV	Lead in PZT based dielectric ceramic materials for capacitors being part of integrated circuits or discrete semiconductors
8(a)	Cadmium and its compounds in one shot pellet type thermal cut-offs (expires on 1 January 2012 and after that date may be used in spare parts for EEE placed on the market before 1 January 2012)
8(b)	Cadmium and its compounds in electrical contacts
9`′	Hexavalent chromium as an anti-corrosion agent of the carbon steel cooling system in absorption refrigerators up to 0.75% by
	weight in the cooling solution
9(b)	Lead in bearing shells and bushes for refrigerant-containing compressors for heating, ventilation, air conditioning and refrigeration (HVACR) applications
11(b)	Lead used in other than C-press compliant pin connector systems (expires on 1 January 2013 and after that date may be used in spare parts for EEE placed on the market before 1 January 2013)
13(a)	Lead in white glasses used for optical applications
13(b)	Cadmium and lead in filter glasses and glasses used for reflectance standards
14	Lead in solders consisting of more than two elements for the connection between the pins and the package of microprocessors with a lead content of more than 80% and less than 85% by weight (expires on 1 January 2011 and after that date may be use in spare parts for EEE placed on the market before 1 January 2011)
15	Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip
	Chip packages
17	Lead halide as radiant agent in High Intensity Discharge (HID) lamps used for professional reprography applications
18(b)	Lead as activator in the fluorescent powder (1% lead by weight or less) of discharge lamps when used as sun tanning lamps containing phosphors such as BSP (BaSi2O5:Pb)
21	Lead and cadmium in printing inks for the application of enamels on glasses, such as borosilicate and soda lime glass
24	Lead in solders for the soldering to machined through hole discoidal and planar array ceramic multilayer capacitors
25	Lead oxide in surface conduction electron emitter displays (SED) used in structural elements, notably in the seal frit and frit ring
29	Lead bound in crystal glass as defined in Annex 1 (Categories 1, 2, 3 and 4) of Council Directive 69/493/EEC
30	Cadmium alloys as electrical/mechanical solder joints to electrical conductors located directly on the voice coil in transducers used in high-powered loudspeakers with sound pressure levels of 100 dB (A) and more
31	Lead in soldering materials in mercury free flat fluorescent lamps (which e.g. are used for liquid crystal displays, design or industrial lighting)
32	Lead oxide in seal frit used for making window assemblies for Argon and Krypton laser tubes

Lead in solders and termination finishes of electrical and electronic components and finishes of printed circuit boards used in ignition modules and other electrical and electronic engine control systems, which for technical reasons must be mounted directly on or in the crankcase or cylinder of hand-held combustion engines (classes SH:1, SH:2, SH:3 of Directive 97/68/EC of the European Parliament and of the Council (2)) (Expires on 31 December 2018)

Cadmium in colour converting II-VI LEDs (< 10 µg Cd per mm2 of light- emitting area) for use in solid state illumination or

Lead in solders for the soldering of thin copper wires of 100 µm diameter and less in power transformers

Lead in the plating layer of high voltage diodes on the basis of a zinc borate glass body

Cadmium and cadmium oxide in thick film pastes used on aluminium bonded beryllium oxide

Lead in cermet-based trimmer potentiometer elements

display systems (expires on 1 July 2014)



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other additional remedies which may be appropriate.

legal action against the Company.

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- 8. 若需要在法院审理程序或者仲裁过程中使用测试报告,客户必须在提交测试样品前将该意图告知本公司。
  Clients wishing to use the Report in court proceedings or arbitration shall inform the Company to that effect prior to submitting the sample for testing.
- 9. 该测试报告的支持数据和信息本公司保存 10 年。个别评审机构有特别要求的,检测数据和报告的保存期可依情况变动。一旦超过上述提交的保存期限,数据和信息将被处理掉。任何情况下,本公司不必提供任何被处理的过期数据或信息。即使本公司事先被告知可能会发生相关的损害,本公司在任何情况下也不必承担任何损害,包括(但不限于)补偿性赔偿、利润损失、数据遗失、或任何形式的特殊损害、附带损害、间接损害、从属损害或任何违反约定、违反承诺、侵权(包括疏忽)、产品责任或其他原因的惩罚性损害。
  - Subject to the variable length of retention time for test data and report stored hereinto as otherwise specifically required by individual accreditation authorities, the Company will only keep the supporting test data and information of the test report for a period of ten years. The data and information will be disposed of after the aforementioned retention period has elapsed. Under no circumstances shall we provide any data and information which has been disposed of after retention period. Under no circumstances shall we be liable for damage of any kind, including (but not limited to) compensatory damages, lost profits, lost data, or any form of special, incidental, indirect, consequential or punitive damages of any kind, whether based on breach of contract of warranty, tort (including negligence), product liability or otherwise, even if we are informed in advance of the possibility of such damages.
- 10. 报告的签发记录可通过登录 http://www.emtek.com.cn/zhengshuchaxun.html 查询。如需进一步查询报告有效性或核实报告,需与本公司联系。 Issuance records of the Report are available on the internet at http://www.emtek.com.cn/zhengshuchaxun.html. Further enquiry of validity or verification of the Report should be addressed to the company.

